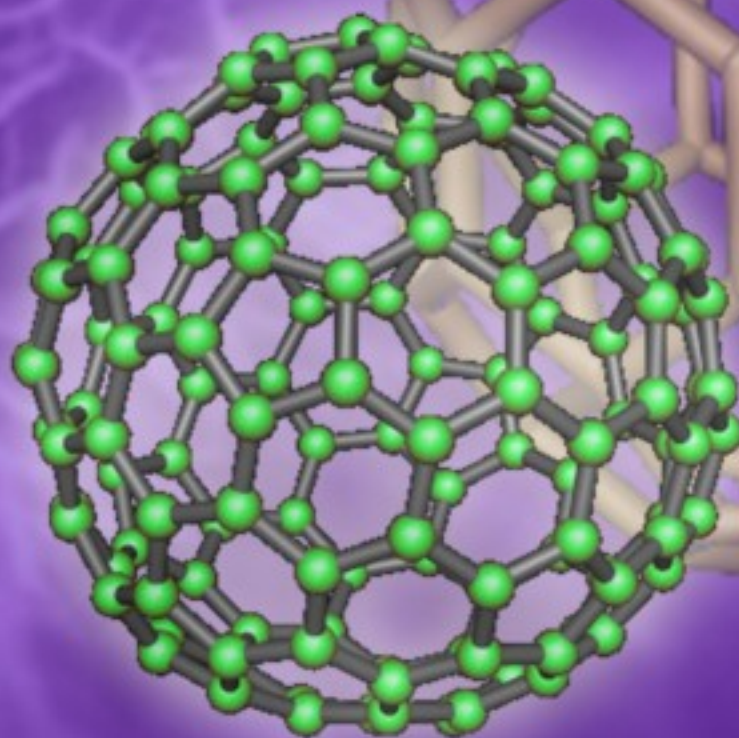
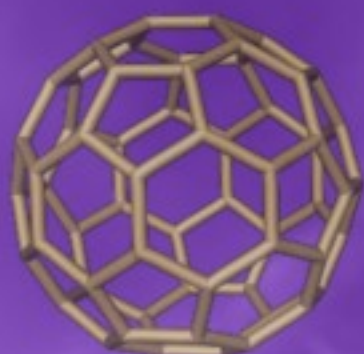


ISSN 1726-5479

SENSORS & TRANSDUCERS

11^{vol. 110}
/09



Nanosensors and Nanodevices

International Frequency Sensor Association Publishing





Editors-in-Chief: professor Sergey Y. Yurish,
Phone: +34 696067716, fax: +34 93 4011989, e-mail: editor@sensorsportal.com

Editors for Western Europe

Meijer, Gerard C.M., Delft University of Technology, The Netherlands
Ferrari, Vittorio, Università di Brescia, Italy

Editor South America

Costa-Felix, Rodrigo, Inmetro, Brazil

Editor for Eastern Europe

Sachenko, Anatoly, Ternopil State Economic University, Ukraine

Editors for North America

Datskos, Panos G., Oak Ridge National Laboratory, USA
Fabien, J. Josse, Marquette University, USA
Katz, Evgeny, Clarkson University, USA

Editor for Asia

Ohyama, Shinji, Tokyo Institute of Technology, Japan

Editor for Asia-Pacific

Mukhopadhyay, Subhas, Massey University, New Zealand

Editorial Advisory Board

- Abdul Rahim, Ruzairi**, Universiti Teknologi, Malaysia
Ahmad, Mohd Noor, Northern University of Engineering, Malaysia
Annamalai, Karthigeyan, National Institute of Advanced Industrial Science and Technology, Japan
Arcega, Francisco, University of Zaragoza, Spain
Arguel, Philippe, CNRS, France
Ahn, Jae-Pyoung, Korea Institute of Science and Technology, Korea
Arndt, Michael, Robert Bosch GmbH, Germany
Ascoli, Giorgio, George Mason University, USA
Atalay, Selcuk, Inonu University, Turkey
Atghiaee, Ahmad, University of Tehran, Iran
Augutis, Vygantas, Kaunas University of Technology, Lithuania
Avachit, Patil Lalchand, North Maharashtra University, India
Ayesh, Aladdin, De Montfort University, UK
Bahreyni, Behraad, University of Manitoba, Canada
Baliga, Shankar, B., General Monitors Transnational, USA
Baoxian, Ye, Zhengzhou University, China
Barford, Lee, Agilent Laboratories, USA
Barlingay, Ravindra, RF Arrays Systems, India
Basu, Sukumar, Jadavpur University, India
Beck, Stephen, University of Sheffield, UK
Ben Bouzid, Sihem, Institut National de Recherche Scientifique, Tunisia
Benachaiba, Chellali, Universitaire de Bechar, Algeria
Binnie, T. David, Napier University, UK
Bischoff, Gerlinde, Inst. Analytical Chemistry, Germany
Bodas, Dhananjay, IMTEK, Germany
Borges Carval, Nuno, Universidade de Aveiro, Portugal
Bousbia-Salah, Mounir, University of Annaba, Algeria
Bouvet, Marcel, CNRS – UPMC, France
Brudzewski, Kazimierz, Warsaw University of Technology, Poland
Cai, Chenxin, Nanjing Normal University, China
Cai, Qingyun, Hunan University, China
Campanella, Luigi, University La Sapienza, Italy
Carvalho, Vitor, Minho University, Portugal
Cecelja, Franjo, Brunel University, London, UK
Cerda Belmonte, Judith, Imperial College London, UK
Chakrabarty, Chandan Kumar, Universiti Tenaga Nasional, Malaysia
Chakravorty, Dipankar, Association for the Cultivation of Science, India
Changhai, Ru, Harbin Engineering University, China
Chaudhari, Gajanan, Shri Shivaji Science College, India
Chavali, Murthy, VIT University, Tamil Nadu, India
Chen, Jiming, Zhejiang University, China
Chen, Rongshun, National Tsing Hua University, Taiwan
Cheng, Kuo-Sheng, National Cheng Kung University, Taiwan
Chiang, Jeffrey (Cheng-Ta), Industrial Technol. Research Institute, Taiwan
Chiriac, Horia, National Institute of Research and Development, Romania
Chowdhuri, Arijit, University of Delhi, India
Chung, Wen-Yaw, Chung Yuan Christian University, Taiwan
Corres, Jesus, Universidad Publica de Navarra, Spain
Cortes, Camilo A., Universidad Nacional de Colombia, Colombia
Courtois, Christian, Universite de Valenciennes, France
Cusano, Andrea, University of Sannio, Italy
D'Amico, Arnaldo, Università di Tor Vergata, Italy
De Stefano, Luca, Institute for Microelectronics and Microsystem, Italy
Deshmukh, Kiran, Shri Shivaji Mahavidyalaya, Barshi, India
Dickert, Franz L., Vienna University, Austria
Dieguez, Angel, University of Barcelona, Spain
Dimitropoulos, Panos, University of Thessaly, Greece
Ding, Jianning, Jiangsu Polytechnic University, China
Djordjevic, Alexandar, City University of Hong Kong, Hong Kong
Donato, Nicola, University of Messina, Italy
Donato, Patricio, Universidad de Mar del Plata, Argentina
Dong, Feng, Tianjin University, China
Drljaca, Predrag, Instersema Sensoric SA, Switzerland
Dubey, Venketesh, Bournemouth University, UK
Enderle, Stefan, Univ. of Ulm and KTB Mechatronics GmbH, Germany
Erdem, Gursan K. Arzum, Ege University, Turkey
Erkmen, Aydan M., Middle East Technical University, Turkey
Estelle, Patrice, Insa Rennes, France
Estrada, Horacio, University of North Carolina, USA
Faiz, Adil, INSA Lyon, France
Fericean, Sorin, Balluff GmbH, Germany
Fernandes, Joana M., University of Porto, Portugal
Francioso, Luca, CNR-IMM Institute for Microelectronics and Microsystems, Italy
Francis, Laurent, University Catholique de Louvain, Belgium
Fu, Weiling, South-Western Hospital, Chongqing, China
Gaura, Elena, Coventry University, UK
Geng, Yanfeng, China University of Petroleum, China
Gole, James, Georgia Institute of Technology, USA
Gong, Hao, National University of Singapore, Singapore
Gonzalez de la Rosa, Juan Jose, University of Cadiz, Spain
Granel, Annette, Goteborg University, Sweden
Graff, Mason, The University of Texas at Arlington, USA
Guan, Shan, Eastman Kodak, USA
Guillet, Bruno, University of Caen, France
Guo, Zhen, New Jersey Institute of Technology, USA
Gupta, Narendra Kumar, Napier University, UK
Hadjiloucas, Sillas, The University of Reading, UK
Haider, Mohammad R., Sonoma State University, USA
Hashsham, Syed, Michigan State University, USA
Hasni, Abdelhafid, Bechar University, Algeria
Hernandez, Alvaro, University of Alcalá, Spain
Hernandez, Wilmar, Universidad Politecnica de Madrid, Spain
Homentcovschi, Dorel, SUNY Binghamton, USA
Horstman, Tom, U.S. Automation Group, LLC, USA
Hsiai, Tzung (John), University of Southern California, USA
Huang, Jeng-Sheng, Chung Yuan Christian University, Taiwan
Huang, Star, National Tsing Hua University, Taiwan
Huang, Wei, PSG Design Center, USA
Hui, David, University of New Orleans, USA
Jaffrezic-Renault, Nicole, Ecole Centrale de Lyon, France
Jaime Calvo-Galleg, Jaime, Universidad de Salamanca, Spain
James, Daniel, Griffith University, Australia
Janting, Jakob, DELTA Danish Electronics, Denmark
Jiang, Liudi, University of Southampton, UK
Jiang, Wei, University of Virginia, USA
Jiao, Zheng, Shanghai University, China
John, Joachim, IMEC, Belgium
Kalach, Andrew, Voronezh Institute of Ministry of Interior, Russia
Kang, Moonho, Sunmoon University, Korea South
Kaniusas, Eugenijus, Vienna University of Technology, Austria
Katake, Anup, Texas A&M University, USA
Kausel, Wilfried, University of Music, Vienna, Austria
Kavasoglu, Nese, Mugla University, Turkey
Ke, Cathy, Tyndall National Institute, Ireland
Khan, Asif, Aligarh Muslim University, Aligarh, India
Sapozhnikova, Ksenia, D.I.Mendeleyev Institute for Metrology, Russia

Kim, Min Young, Kyungpook National University, Korea South
Ko, Sang Choon, Electronics and Telecommunications Research Institute, Korea South
Kockar, Hakan, Balikesir University, Turkey
Kotulska, Malgorzata, Wroclaw University of Technology, Poland
Kratz, Henrik, Uppsala University, Sweden
Kumar, Arun, University of South Florida, USA
Kumar, Subodh, National Physical Laboratory, India
Kung, Chih-Hsien, Chang-Jung Christian University, Taiwan
Lacnjevac, Caslav, University of Belgrade, Serbia
Lay-Ekuakille, Aime, University of Lecce, Italy
Lee, Jang Myung, Pusan National University, Korea South
Lee, Jun Su, Amkor Technology, Inc. South Korea
Lei, Hua, National Starch and Chemical Company, USA
Li, Genxi, Nanjing University, China
Li, Hui, Shanghai Jiaotong University, China
Li, Xian-Fang, Central South University, China
Liang, Yuanchang, University of Washington, USA
Liawruangrath, Saisunee, Chiang Mai University, Thailand
Liew, Kim Meow, City University of Hong Kong, Hong Kong
Lin, Hermann, National Kaohsiung University, Taiwan
Lin, Paul, Cleveland State University, USA
Linderholm, Pontus, EPFL - Microsystems Laboratory, Switzerland
Liu, Aihua, University of Oklahoma, USA
Liu Changgeng, Louisiana State University, USA
Liu, Cheng-Hsien, National Tsing Hua University, Taiwan
Liu, Songqin, Southeast University, China
Lodeiro, Carlos, University of Vigo, Spain
Lorenzo, Maria Encarnacio, Universidad Autonoma de Madrid, Spain
Lukaszewicz, Jerzy Pawel, Nicholas Copernicus University, Poland
Ma, Zhanfang, Northeast Normal University, China
Majstorovic, Vidosav, University of Belgrade, Serbia
Marquez, Alfredo, Centro de Investigacion en Materiales Avanzados, Mexico
Matay, Ladislav, Slovak Academy of Sciences, Slovakia
Mathur, Prafull, National Physical Laboratory, India
Maurya, D.K., Institute of Materials Research and Engineering, Singapore
Mekid, Samir, University of Manchester, UK
Melnyk, Ivan, Photon Control Inc., Canada
Mendes, Paulo, University of Minho, Portugal
Mennell, Julie, Northumbria University, UK
Mi, Bin, Boston Scientific Corporation, USA
Minas, Graca, University of Minho, Portugal
Moghavvemi, Mahmoud, University of Malaya, Malaysia
Mohammadi, Mohammad-Reza, University of Cambridge, UK
Molina Flores, Esteban, Benemérita Universidad Autónoma de Puebla, Mexico
Moradi, Majid, University of Kerman, Iran
Morello, Rosario, University "Mediterranea" of Reggio Calabria, Italy
Mounir, Ben Ali, University of Sousse, Tunisia
Mulla, Imtiaz Sirajuddin, National Chemical Laboratory, Pune, India
Neelamegam, Periasamy, Sastra Deemed University, India
Neshkova, Milka, Bulgarian Academy of Sciences, Bulgaria
Oberhammer, Joachim, Royal Institute of Technology, Sweden
Ould Lahoucine, Cherif, University of Guelma, Algeria
Pamidighanta, Sayanu, Bharat Electronics Limited (BEL), India
Pan, Jisheng, Institute of Materials Research & Engineering, Singapore
Park, Joon-Shik, Korea Electronics Technology Institute, Korea South
Penza, Michele, ENEA C.R., Italy
Pereira, Jose Miguel, Instituto Politecnico de Setebal, Portugal
Petsev, Dimiter, University of New Mexico, USA
Pogacnik, Lea, University of Ljubljana, Slovenia
Post, Michael, National Research Council, Canada
Prance, Robert, University of Sussex, UK
Prasad, Ambika, Gulbarga University, India
Prateepasen, Asa, Kingmoungut's University of Technology, Thailand
Pullini, Daniele, Centro Ricerche FIAT, Italy
Pumera, Martin, National Institute for Materials Science, Japan
Radhakrishnan, S., National Chemical Laboratory, Pune, India
Rajanna, K., Indian Institute of Science, India
Ramadan, Qasem, Institute of Microelectronics, Singapore
Rao, Basuthkar, Tata Inst. of Fundamental Research, India
Raouf, Kosai, Joseph Fourier University of Grenoble, France
Reig, Candid, University of Valencia, Spain
Restivo, Maria Teresa, University of Porto, Portugal
Robert, Michel, University Henri Poincare, France
Rezazadeh, Ghader, Urmia University, Iran
Royo, Santiago, Universitat Politècnica de Catalunya, Spain
Rodriguez, Angel, Universidad Politécnica de Catalunya, Spain
Rothberg, Steve, Loughborough University, UK
Sadana, Ajit, University of Mississippi, USA
Sadeghian Marnani, Hamed, TU Delft, The Netherlands
Sandacci, Serghei, Sensor Technology Ltd., UK
Saxena, Vibha, Bhabha Atomic Research Centre, Mumbai, India
Schneider, John K., Ultra-Scan Corporation, USA
Seif, Selemeni, Alabama A & M University, USA
Seifter, Achim, Los Alamos National Laboratory, USA
Sengupta, Deepak, Advance Bio-Photonics, India
Shearwood, Christopher, Nanyang Technological University, Singapore
Shin, Kyuho, Samsung Advanced Institute of Technology, Korea
Shmaliy, Yuriy, Kharkiv National Univ. of Radio Electronics, Ukraine
Silva Girao, Pedro, Technical University of Lisbon, Portugal
Singh, V. R., National Physical Laboratory, India
Slomovitz, Daniel, UTE, Uruguay
Smith, Martin, Open University, UK
Soleymannpour, Ahmad, Damghan Basic Science University, Iran
Somani, Prakash R., Centre for Materials for Electronics Technol., India
Srinivas, Talabattula, Indian Institute of Science, Bangalore, India
Srivastava, Arvind K., Northwestern University, USA
Stefan-van Staden, Raluca-Ioana, University of Pretoria, South Africa
Sunriddetchka, Sarun, National Electronics and Computer Technology Center, Thailand
Sun, Chengliang, Polytechnic University, Hong-Kong
Sun, Dongming, Jilin University, China
Sun, Junhua, Beijing University of Aeronautics and Astronautics, China
Sun, Zhiqiang, Central South University, China
Suri, C. Raman, Institute of Microbial Technology, India
Sysoev, Victor, Saratov State Technical University, Russia
Szewczyk, Roman, Industrial Research Inst. for Automation and Measurement, Poland
Tan, Ooi Kiang, Nanyang Technological University, Singapore,
Tang, Dianping, Southwest University, China
Tang, Jaw-Luen, National Chung Cheng University, Taiwan
Teker, Kasif, Frostburg State University, USA
Thumbavanam Pad, Kartik, Carnegie Mellon University, USA
Tian, Gui Yun, University of Newcastle, UK
Tsiantos, Vassilios, Technological Educational Institute of Kaval, Greece
Tsigara, Anna, National Hellenic Research Foundation, Greece
Twomey, Karen, University College Cork, Ireland
Valente, Antonio, University, Vila Real, - U.T.A.D., Portugal
Vaseashta, Ashok, Marshall University, USA
Vazquez, Carmen, Carlos III University in Madrid, Spain
Vieira, Manuela, Instituto Superior de Engenharia de Lisboa, Portugal
Vigna, Benedetto, STMicroelectronics, Italy
Vrba, Radimir, Brno University of Technology, Czech Republic
Wandelt, Barbara, Technical University of Lodz, Poland
Wang, Jiangping, Xi'an Shiyu University, China
Wang, Kedong, Beihang University, China
Wang, Liang, Advanced Micro Devices, USA
Wang, Mi, University of Leeds, UK
Wang, Shinn-Fwu, Ching Yun University, Taiwan
Wang, Wei-Chih, University of Washington, USA
Wang, Wensheng, University of Pennsylvania, USA
Watson, Steven, Center for NanoSpace Technologies Inc., USA
Weiping, Yan, Dalian University of Technology, China
Wells, Stephen, Southern Company Services, USA
Wolkenberg, Andrzej, Institute of Electron Technology, Poland
Woods, R. Clive, Louisiana State University, USA
Wu, DerHo, National Pingtung Univ. of Science and Technology, Taiwan
Wu, Zhaoyang, Hunan University, China
Xiu Tao, Ge, Chuzhou University, China
Xu, Lisheng, The Chinese University of Hong Kong, Hong Kong
Xu, Tao, University of California, Irvine, USA
Yang, Dongfang, National Research Council, Canada
Yang, Wuqiang, The University of Manchester, UK
Yang, Xiaoling, University of Georgia, Athens, GA, USA
Yaping Dan, Harvard University, USA
Ymeti, Aurel, University of Twente, Netherland
Yong Zhao, Northeastern University, China
Yu, Haihu, Wuhan University of Technology, China
Yuan, Yong, Massey University, New Zealand
Yufera Garcia, Alberto, Seville University, Spain
Zagnoni, Michele, University of Southampton, UK
Zamani, Cyrus, Universitat de Barcelona, Spain
Zeni, Luigi, Second University of Naples, Italy
Zhang, Minglong, Shanghai University, China
Zhang, Quintao, University of California at Berkeley, USA
Zhang, Weiping, Shanghai Jiao Tong University, China
Zhang, Wenming, Shanghai Jiao Tong University, China
Zhang, Xueji, World Precision Instruments, Inc., USA
Zhong, Haoxiang, Henan Normal University, China
Zhu, Qing, Fujifilm Dimatix, Inc., USA
Zorzano, Luis, Universidad de La Rioja, Spain
Zourob, Mohammed, University of Cambridge, UK

Contents

Volume 110
Issue 11
November 2009

www.sensorsportal.com

ISSN 1726-5479

Research Articles

Sensors Based on Nanostructured Materials: Book Review <i>Sergey Y. YURISH</i>	1
Glucose Binding Protein as a Novel Optical Glucose Nanobiosensor <i>Majed DWEIK</i>	1
Hydrogen Sensor Based on Carbon Nano-tube Fortified by Palladium <i>A. Kazemzadeh, A. F. Hessari, M. Kashani, H. Azizi and N. Jafari</i>	9
Nanostructured ZrO₂ Thick Film Resistors as H₂-Gas Sensors Operable at Room Temperature <i>K. M. Garadkar, B. S. Shirke, Y. B. Patil and D. R. Patil</i>	17
Pull-in Phenomena and Dynamic Response of a Capacitive Nano-beam Switch <i>Farid Vakili-Tahami, Hamed Mobki, Ali-asghar keyvani-janbahan, Ghader Rezazadeh</i>	26
Palladium Surface Modification of Nanocrystalline Sol-Gel derived Zinc Oxide Thin Films and its Effect on Methane Sensing <i>P. Bhattacharyya, S. Maji, S. Biswas, A. Sengupta, T. Maji, H. Saha</i>	38
Gas Sensing Properties of Indium Tin Oxide Nanofibers <i>Shiyong Xu, Yong Shi</i>	47
Design, Modeling and Optimization of a Piezoelectric Pressure Sensor based on a Thin-Film PZT Membrane Containing Nanocrystalline Powders <i>Vahid Mohammadi, Mohammad Hossein Sheikhi</i>	56
Synthesis and Properties of Thin Film Nanocomposites Sn-Y-O for Gas Sensors <i>Stanislav Rembeza, Ekaterina Rembeza, Elena Russkih, Natalia Kosheleva</i>	71
Electroanalytical Nanoparticles Electrode based on NanoTiO₂/MWCNTs Mixture <i>Ganchimeg Perenlei, Wee Tee Tan</i>	78
Structural Properties of Nanosized NiFe₂O₄ for LPG Sensor <i>N. N. Gedam, A. V. Kadu, P. R. Padole, A. B. Bodade and G. N. Chaudhari</i>	86
Low-Cost Wireless Nanotube Composite Sensor for Damage Detection of Civil Infrastructure <i>Mohamed Saafi, Lanouar Kaabi</i>	96
Cross Linking Polymers (PVA & PEG) with TiO₂ Nanoparticles for Humidity Sensing <i>Monika Joshi and R. P. Singh</i>	105
Resolution Enhancement of Thermal and Optical Nanolithography Using an Organic Dry Developing Resist and an Optimized Tip <i>Salman Noach, Michael Manevich, Naftali P. Eisenberg and Eli Flaxer</i>	112

Wireless Sensor Network: Modeling and Analysis of MEMS based Nano-Nodes <i>Rohit Pathak, Satyadhar Joshi.....</i>	120
Respiration and Heartbeat Measurement for Sleep Monitoring using a Flexible AIN Piezoelectric Film Sensor <i>Nan Bu, Naohiro Ueno and Osamu Fukuda.....</i>	131
Design Optimization of Cantilever based MEMS Micro-accelerometer for High-g Applications <i>B. D. Pant, Shelley Goel, P. J. George and S. Ahmad</i>	143

Authors are encouraged to submit article in MS Word (doc) and Acrobat (pdf) formats by e-mail: editor@sensorsportal.com
Please visit journal's webpage with preparation instructions: <http://www.sensorsportal.com/HTML/DIGEST/Submission.htm>

International Frequency Sensor Association (IFSA).

SENSORDEVICES 2010:

**The First International Conference
on Sensor Device Technologies and Applications**

July 18 - 25, 2010 - Venice, Italy



The inaugural event SENSORDEVICES 2010, The First International Conference on Sensor Device Technologies and Applications, initiates a series of events focusing on sensor devices themselves, the technology-capturing style of sensors, special technologies, signal control and interfaces, and particularly sensors-oriented applications. The evolution of the nano- and microtechnologies, nanomaterials, and the new business services make the sensor device industry and research on sensor-themselves very challenging.

Conference tracks

Sensor devices
Sensor device technologies
Sensors signal conditioning and interfacing circuits

Medical devices and sensors applications
Sensors domain-oriented devices, technologies, and applications
Sensor-based localization and tracking technologies

Important dates

Submission (full paper): February 20, 2010
Notification: March 25, 2010
Registration: April 15, 2010
Camera ready: April 20, 2010



<http://www.iaria.org/conferences2010/SENSORDEVICES10.html>

Sensors Based on Nanostructured Materials: Book Review

Yurish S. Y.

International Frequency Sensor Association (IFSA),

Tel.: +34 696067716, fax: +34 93 6641970

E-mail: ifsa@sensorsportal.com



New published by Springer 326-page book *Sensors Based on Nanostructure Materials* written by experts from Canada, Spain and USA (edited by Francisco J. Arregui, Spain) provides the reader with a deep understanding of different techniques and methods of fabrication materials on the nanometer scale, and using it for various sensors such as temperature, pressure, strain, radiation, flow, magnetic fields, gases, volatile organic compounds, ions, chemical, bio-, immuno-, DNA, glucose, magnetic and others.

The book is organized by the logic way and topic of high interest. An introduction is following by nine chapters on carbon and non-carbon nanotubes, nanosensors and alternative nanostructured sensors such as nanowires, nanobelts, quantum dots, etc. Particular attention is given to nanostructured magnetic sensors, encapsulated probes and optical fiber sensors.

Each chapters of this book are independent and self-contained. It contains an introduction to the specific topic, various fabrication methods of nanostructured materials for sensing and known applications. References lists, which well reflect the state of the art of each topic are ending of each chapters. Some commercially available products are also described in the book.

Most of the contributors are editorial boards members of journals related to the nanoscience and three of them are editors-in-chiefs of different journals.

Sensors Based on Nanostructure Materials is suitable for academic and industrial researchers, engineers and PhD students. It is a valuable source for those who need to have a summary of nanosensors based on nanostructured materials fabricated with many different techniques.

For online order please see:

http://www.sensorsportal.com/HTML/BOOKSTORE/Nanostructured_materials.htm

2009 Copyright ©, International Frequency Sensor Association (IFSA). All rights reserved.
(<http://www.sensorsportal.com>)

NanoSEE 08

Nano materials industrial Status and Expected Evolution

UNIQUE REPORT DESCRIBING NANO MATERIAL WORLD UP TO 2012

This report is designed to understand the market for nanomaterials, the players including the organizations, as well as the accessibility of the market. It highlights the technical functions made possible by nanomaterials to create our daily nanoproducts.

Reports answer to:

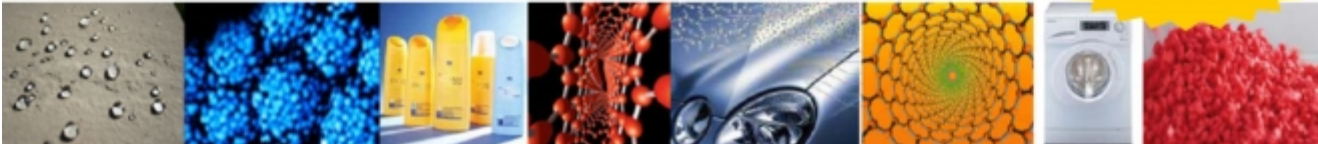
- What are nanomaterials? What are they used for?
- What are the benefits of nanomaterials?
- What is the market for nanomaterials - 2007-2012?
- Who are the key players? How is the industry organized?

Unique proposition selling

- Complete overview of the nanomaterials world: products, players, applications, markets...
- Understanding the industrial value chain

<http://www.sensorsportal.com/HTML/NanoSEE.htm>

IFSA offers
a SPECIAL PRICE



CENICS 2010:

The Third International Conference on
Advances in Circuits, Electronics and Micro-electronics

July 18 - 25, 2010 - Venice, Italy



CENICS 2010 continues a series of events initiated in 2008, capturing the advances on special circuits, electronics, and micro-electronics on both theory and practice, from fabrication to applications using these special circuits and systems. The tracks cover fundamentals of design and implementation, techniques for deployment in various applications, and advances in signal processing. The topics suggested can be discussed in term of concepts, state of the art, research, standards, implementations, running experiments, applications, and industrial case studies.

Conference tracks

Semiconductors and applications Design, models and languages Signal processing circuits Arithmetic computational circuits Microelectronics	Electronics technologies Special circuits Consumer electronics Application-oriented electronics
--	--

Important dates

Submission (full paper):	February 20, 2010
Notification:	March 25, 2010
Registration:	April 15, 2010
Camera ready:	April 20, 2010

<http://www.iaria.org/conferences2010/CENICS10.html>



Guide for Contributors

Aims and Scope

Sensors & Transducers Journal (ISSN 1726-5479) provides an advanced forum for the science and technology of physical, chemical sensors and biosensors. It publishes state-of-the-art reviews, regular research and application specific papers, short notes, letters to Editor and sensors related books reviews as well as academic, practical and commercial information of interest to its readership. Because it is an open access, peer review international journal, papers rapidly published in *Sensors & Transducers Journal* will receive a very high publicity. The journal is published monthly as twelve issues per annual by International Frequency Association (IFSA). In addition, some special sponsored and conference issues published annually. *Sensors & Transducers Journal* is indexed and abstracted very quickly by Chemical Abstracts, IndexCopernicus Journals Master List, Open J-Gate, Google Scholar, etc.

Topics Covered

Contributions are invited on all aspects of research, development and application of the science and technology of sensors, transducers and sensor instrumentations. Topics include, but are not restricted to:

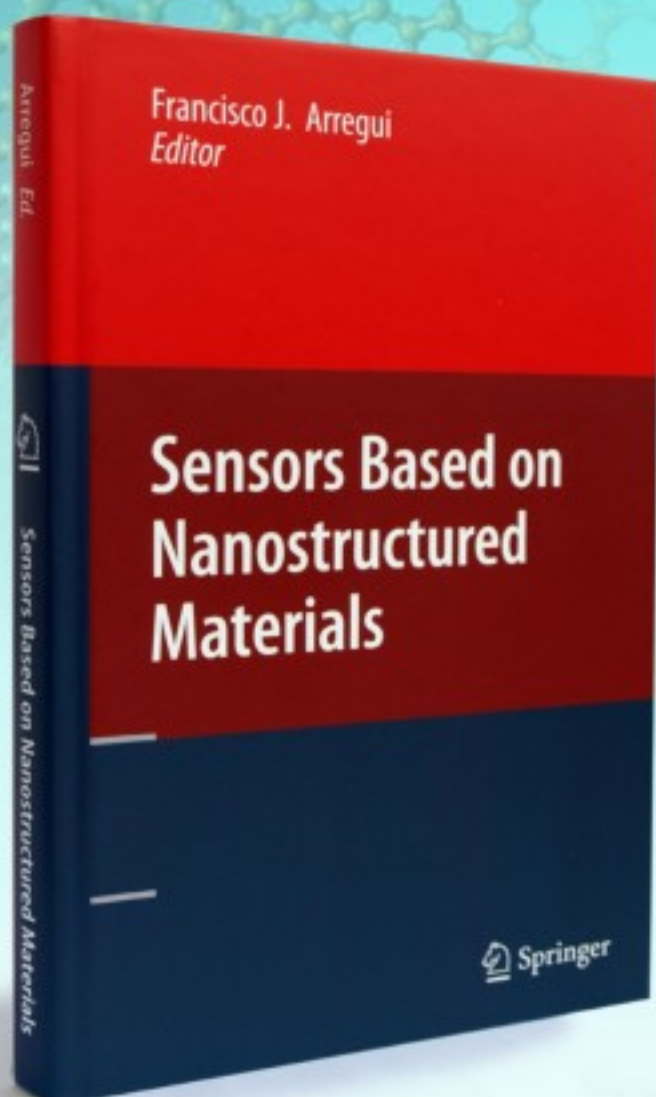
- Physical, chemical and biosensors;
- Digital, frequency, period, duty-cycle, time interval, PWM, pulse number output sensors and transducers;
- Theory, principles, effects, design, standardization and modeling;
- Smart sensors and systems;
- Sensor instrumentation;
- Virtual instruments;
- Sensors interfaces, buses and networks;
- Signal processing;
- Frequency (period, duty-cycle)-to-digital converters, ADC;
- Technologies and materials;
- Nanosensors;
- Microsystems;
- Applications.

Submission of papers

Articles should be written in English. Authors are invited to submit by e-mail editor@sensorsportal.com 8-14 pages article (including abstract, illustrations (color or grayscale), photos and references) in both: MS Word (doc) and Acrobat (pdf) formats. Detailed preparation instructions, paper example and template of manuscript are available from the journal's webpage: <http://www.sensorsportal.com/HTML/DIGEST/Submission.htm> Authors must follow the instructions strictly when submitting their manuscripts.

Advertising Information

Advertising orders and enquires may be sent to sales@sensorsportal.com Please download also our media kit: http://www.sensorsportal.com/DOWNLOADS/Media_Kit_2009.pdf



'Sensors Based on Nanostructured Materials presents the many different techniques and methods of fabricating materials on the nanometer scale and specifically, the utilization of these resources with regard to sensors. The techniques which are described here are studied from an application-oriented perspective, providing the reader with a broader view of the types of nanostructured sensors available.

Sensors Based on Nanostructures Materials is suitable for academic and industrial research scientists as well as engineers.'

"It is a valuable source for those who need to have a summary of nanosensors based on nanostructured materials fabricated with many different techniques."
(Sergey Y. Yurish, *Sensors & Transducers*, Vol.110, Issue 11, November 2009).

Order online:

http://www.sensorsportal.com/HTML/BOOKSTORE/Nanostructured_materials.htm